



- NOTES:
- MATERIAL:
HOUSING : LCP 30% GLASS FILLED
UL94 V-0,COLOR BLACK
TERMINAL: PHOSPHOR BRONZE 0.12MM REF THICKNESS
 - PLATING FINISHES:
TERMINAL:
CONTACT AREA: 0.8 MICROMETER MIN GOLD
SOLDER TAIL: GOLD FLASH 0.05 MICROMETER MIN.
UNDERPLATING: 2 MICROMETER NICKEL OVERALL
 - PRODUCT SPECIFICATION: PS-47550-001
 - PACKAGING SPECIFICATION: PK-47550-001
 - NO SHARP EDGE INTERFACING WITH THE PCB OR SIM CARD
 - CONTACT MUST NOT EXTENDED HOUSING EDGE DURING DEFLECTION AND MUST LOWER THAN HOUSING LEVEL AFTER 3 TIMES REFLOW
 - PRODUCT COMPLIANT TO ROHS DIRECTIVE 2002/95/EC AND ELV DIRECTIVE 2000/53/EC

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|--|--|---|----------------------|----------------------------|---------------------|--------------|------------------------|------------------------|--|------------------------------|---------------------|
| RELEASED EC NO: S2015-0672 DRWING:GMENARLY 2014/11/28 CHKD:SICHEONG 2014/12/19 APPR:KHLIM 2014/12/19 | QUALITY SYMBOLS $F_A=0$ $F_G=0$ $F_P=0$ | GENERAL TOLERANCES (UNLESS SPECIFIED) | | DIMENSION STYLE MM ONLY | | SCALE NTS | DESIGN UNITS METRIC | THIRD ANGLE PROJECTION | | | |
| | | 4 PLACES ± --- ± --- | 3 PLACES ± --- ± --- | 2 PLACES ± 0.20 ± --- | 1 PLACE ± --- ± --- | 0 PLACE ± ± | DRAWN BY GMENARLY | DATE 2014/11/28 | TITLE 1.30MM HEIGHT BLOCK SIM CONNECTOR | | |
| | | ANGULAR ± 3 ° | | | | | CHECKED BY SCHEONG | DATE 2014/12/19 | molex | | |
| | | DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS | | | | | APPROVED BY KHLIM | DATE 2014/12/19 | MATERIAL NO. 47550-0001 | DOCUMENT NO. SD-47550-002 | SHEET NO. 1 OF 1 |
| 1 | REV | THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION | | | | | | | | | |